

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

ent Application

Commissioner for Patents

Washington, D.C. 20231

Re: Inventor(s): John F. Arackaparambil, Tom Chi, Billy Chow, Patrick M. D'Souza, Parris Hawkins, Charles Huang,

Jett Jensen, Badri N. Krishnamurthy, Pradeep M. Kulkarni, Prakash M. Kulkarni, Wen Fong Lin,

Shantha Mohan, Bishnu Nandy, Huey-Shin Yuan

## Title: COMPUTER INTEGRATED MANUFACTURING TECHNIQUES

Transmitted herewith is the patent application identified above, including:

- X Specification, claims and abstract, totaling 41 pages.
- X Drawings totaling 10 pages, \_ Formal X Informal.

Executed Declaration and Power of Attorney.

Assignment of the invention to Applied Materials, Inc.

Assignment Recordation Cover Sheet

FEE CALCUI	LATION				
Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Total Claims	69	- 20 =	49	X \$18.00	882.00
☐ Independent Claims	10	- 3 =	7	X \$78.00	546.00
Basic Filing Fee \$760.00					\$760.00
TOTAL FEES					\$2,188.00

- XX The Commissioner is hereby authorized to charge \$2,188.00 to Deposit Account No. 01-1651.
- XX The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. <u>01-1651</u>. A duplicate copy of this transmittal is enclosed.

XX Please address all future correspondence to:

PATENT COUNSEL APPLIED MATERIALS, INC. Legal Affairs Department P.O.BOX 450A Santa Clara, CA. 95052

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: Box Patent Application, Assistant Commissioner for Patents, Washington, D.C. 20231.

Express Mail Receipt No. EL26633798145

Date of Deposit 7 29 99

Signature Seel Mulcaly

Respectfully submitted,

Robert W. Mulcahy Registration No. 25,436